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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/727,550	12/05/2003	Ming-Dou Ker	6811954-15U1	8001
570	7590	08/23/2006	EXAMINER	
AKIN GUMP STRAUSS HAUER & FELD L.L.P. ONE COMMERCE SQUARE 2005 MARKET STREET, SUITE 2200 PHILADELPHIA, PA 19103			NGUYEN, DAO H	
			ART UNIT	PAPER NUMBER
			2818	

DATE MAILED: 08/23/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No. 10/727,550	Applicant(s) KER ET AL.	
	Examiner Dao H. Nguyen	Art Unit 2818	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 15 June 2006.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-31 and 37-39 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☒ Claim(s) 16-25 is/are allowed.
- 6) ☒ Claim(s) 1-15, 26, 27, 29-31 and 37-39 is/are rejected.
- 7) ☒ Claim(s) 28 is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

1. In response to the communications dated 06/15/2006, claims 1-31 and 37-39 are active in this application.

Claim(s) 32-36 have been cancelled.

Claims 37-39 are newly added claims.

Remarks

2. Applicant's argument(s), filed 06/15/2006, have been fully considered, but are moot in view of Ker et al., US Patent Application Publication No. 2002/0130390.

Claim Rejections - 35 U.S.C. § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

4. **Claim 1 is rejected under 35 U.S.C. 102(e) as being anticipated by US Patent Application Publication No. 2002/0130390 by Ker et al. (Wang).**

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Regarding claim 1, Wang discloses a semiconductor device suitable for applications in an electrostatic discharge (ESD) protection circuit, as shown in fig. 12, comprising:

- a semiconductor substrate 46;
- a first well 60 formed in the substrate 46;
- a second well 58 formed in the substrate 46; and
- a first doped region 62 formed in the second well 58, and
- a deep well 54 formed in the substrate 46 that physically isolates the substrate 46 from at least the second well 58,

wherein the first well 60, the second well 58, and the first doped region 62 collectively form a parasitic bipolar junction transistor (BJT), and wherein the first well 60 is the collector of the BJT, the second well 58 is the base of the BJT, and the first doped region 62 is the emitter of the BJT, and

wherein the deep well 54 does not form a terminal of a transistor.

See paras. [0017] and [0045-0046].

Note that doped regions forming the emitter and collector are well regions because they are source of N^+ type (or P^+ type) semiconductor which are needed for the flowing of current. According to Merriam-Webster's Collegiate Dictionary, Tenth Edition, a well is a source from which something may be drawn as needed.

Claim Rejections - 35 U.S.C. § 103

5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

6. **Claim(s) 1-3, 15, 26, and 37-39 are rejected under 35 U.S.C. 103 (a) as being unpatentable over U.S. Patent No. 6,566,715 to Ker et al. (Ker) in view of U.S. Patent Application Publication No. 2002/0130390 by Ker et al. (Wang).**

Regarding claim 1, Ker discloses a semiconductor device suitable for applications in an electrostatic discharge (ESD) protection circuit, as shown in figs. 5b, 6, 9, and 11, comprising:

a semiconductor substrate 30;

a first well 36 formed in the substrate 30;

a second well 32 formed in the substrate 30; and

a first doped region 38 formed in the second well 32, wherein the first well 36, the second well 32, and the first doped region 38 collectively form a parasitic bipolar junction transistor (BJT), and wherein the first well 36 is the collector of the BJT, the second well 32 is the base of the BJT, and the first doped region 38 is the emitter of the BJT.

See also col. 4, lines 6-64; and col. 6, line 60 to col. 7, line 13.

Note that doped regions forming the emitter and collector are well regions because they are source of N^+ type (or P^+ type) semiconductor which are needed for the flowing of current. According to Merriam-Webster's Collegiate Dictionary, Tenth Edition, a well is a source from which something may be drawn as needed.

Ker does not disclose a deep well formed in the substrate that physically isolates the substrate from at least the second well, wherein the deep well does not form a terminal of a transistor.

Wang discloses a semiconductor device suitable for applications in an electrostatic discharge (ESD) protection circuit, as shown in fig. 12, comprising a deep well 54 formed in a substrate 46 that physically isolates the substrate 46 from at least a second well 58, wherein the deep well 54 does not form a terminal of a transistor. See paras. [0017] and [0045-0046].

It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the invention of Ker so that it would further include a deep well as taught by Wang in order preventing noise from migrating through the substrate, and/or to increase the efficiency of the ESD circuit. See paras. [0045-0046] of Wang.

Regarding claim 2, Ker/Wang discloses the semiconductor device wherein the first well 36 is n-type, the second well 32 is p-type, the first doped region 38 is n-type, and the parasitic BJT is an NPN BJT. See fig. 5b of Ker.

Regarding claim 3, Ker/Wang discloses the device comprising all claimed limitations. See col. 6, line 60 to col. 7, line 13 of Ker.

Regarding claim 15, Ker/Wang discloses the semiconductor device further comprising a second doped region 40 for receiving a trigger current or a trigger voltage in an ESD event, wherein a portion of the second doped region is formed in the first well, and another portion of the second doped region is formed in the second well, and wherein the trigger current or the trigger voltage triggers the BJT to discharge the ESD in the ESD event. See figs. 5 and col. 4, line 51 to col. 7, line 9 of Ker.

Regarding claim 26, Ker discloses a semiconductor device suitable for applications in an electrostatic discharge (ESD) protection circuit, as shown in figs. 5b, 6, 9, 11, comprising:

- a semiconductor substrate 30;
- a first well 38 (the left well) formed in the substrate 30;
- a second well 32 formed in the substrate;
- a third well 38 (the right well) formed in the substrate 30;

a first doped region 36 (the left doped region) formed in the second well 32; and

a second doped region 36 (the right doped region) formed in the second well 32, wherein the first well 38, the second well 32, and the first doped region 36 collectively form a first parasitic bipolar junction transistor (BJT), and the second well 32, the third well 38, and the second doped region 36 collectively form a second parasitic BJT, and

wherein the first well 38 is the emitter of the first BJT, the third well 38 is the emitter of the second BJT, the second well 32 is the base of both of the first and the second BJTs, the first doped region 36 is the collector of the first BJT, and the second doped region 36 is the collector of the second BJT.

See col. 4, line 10 to col. 7, line 25.

Note that doped regions forming the emitter and collector are well regions because they are source of N^+ type (or P^+ type) semiconductor which are needed for the flowing of current. According to Merriam-Webster's Collegiate Dictionary, Tenth Edition, a well is a source from which something may be drawn as needed.

Ker does not disclose a deep well formed in the substrate that physically isolates the substrate from the first, second, and third wells.

Wang discloses a semiconductor device suitable for applications in an electrostatic discharge (ESD) protection circuit, as shown in fig. 12, comprising a deep

well 54 formed in a substrate 46 that physically isolates the substrate 46 from the first, second, and third wells 38, 32, 38, respectively. See paras. [0017] and [0045-0046].

It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the invention of Ker so that it would further include a deep well as taught by Wang in order preventing noise from migrating through the substrate, and/or to increase the efficiency of the ESD circuit. See paras. [0045-0046] of Wang.

Regarding claims 37 and 39, Ker/Wang discloses the semiconductor device wherein the deep well 54 is an n-type. See fig. 12 of Wang.

Regarding claim 38, Ker/Wang discloses the semiconductor device wherein the deep well further physically isolates the substrate from the first well. See fig. 12 of Wang.

7. Claim(s) 4-14, 27, and 29-31 are rejected under 35 U.S.C. 103 (a) as being unpatentable over U.S. Patent No. 6,566,715 to Ker et al., in view of U.S. Patent Application Publication No. 2002/0130390 by Ker et al., and further in view of U.S. Patent No. 5,637,901 to Beigel. et al.

Regarding claim 4, Ker/Wang discloses the semiconductor device further comprising:

a contact region (silicide material collector contact region shown by shaded region in the first well or collector 36 (col. 4, lines 38-39)) formed in the first well 44; and
a third doped region 40 formed in the substrate 30,
wherein the contact region is a contact to the first well 36, and
wherein the third doped region 40 and the second well 32 are of a same type of conductivity (p-type), and the third doped region 40 is a contact to the second well 32.
See fig. 5b of Ker.

Ker/Wang teaches that the collector 36 is coupled to pad 60 (fig. 6) via the contact region made by silicide material (col. 4, lines 38-39 and lines 53-56) but not by a second doped region having the same conductivity type as that of the first well or collector 36.

Beigel discloses a semiconductor device for an ESD circuit, as shown in figs. 3, 5, 6, wherein electrical contact(s) to the collector/emitter and/or base is/are made via highly doped layer(s) which correspondingly has/have the same type of conductivity with that of the collector/emitter and base (N^{++} doped layer 26 is formed in, and contacts, the N-type collector 24 (col. 3, lines 22-25); and P^{++} doped layer 36 is formed in, and contacts, the P-type base 32 (col. 3, lines 36-40)).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to further modify the invention of Ker/Wang so that the

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silicide contact regions formed in the collector/emitter, and base regions are replaced by correspondingly highly doped regions of N-type and/or P-type as those of Beigel in order to assure good electrical contacts to the collector/emitter, and base regions. See col. 3, lines 34-40 of Beigel.

Such modification would create a second doped region having the same type of conductivity (n-type) as that of the first well, and contact to the first well.

Regarding claim 5, Ker/Wang/Beigel disclose the semiconductor device further comprising an ESD detection circuit 62, wherein the first doped region 38 is connectable to a power supply (VSS), wherein the second doped region (Collector contact) is connectable to a contact pad 60 for receiving an ESD, and wherein the third doped region 40 is connectable to the ESD detection circuit 62 coupled to the contact pad 60 for detecting the ESD. See figs. 5-6 and col. 4, lines 51-57 of Ker.

Regarding claim 6, Ker/Wang/Beigel disclose the semiconductor device wherein the ESD detection circuit 62 provides a trigger current to the third doped region 40 in an ESD event, and wherein the trigger current triggers the parasitic BJT to conduct the ESD current from the second doped region to the first doped region or from the first doped region to the second doped region. See col. 4, line 56-64 of Ker.

Regarding claims 7, 8, Ker/Wang/Beigel disclose the semiconductor device comprising all claimed limitations. See figs. 5b, 6, 9, 11, and col. 4, line 51 to col. 7, line 9 of Ker.

Regarding claim 9, Ker/Wang/Beigel discloses the semiconductor device further comprising a fourth doped region 46 formed in the second well 32, wherein the fourth doped region 46 and the second well 32 are of a same type of conductivity (p-type), wherein the fourth doped region is also a contact to the second well, wherein the third doped region 40 and the fourth doped region 46 are spaced apart from each other, and wherein the fourth doped region is connectable to the power supply. See figs. 5b, 6, 9, 11, and col. 4, line 51 to col. 7, line 9 of Ker.

Regarding claims 10-14, Ker/Wang/Beigel disclose the semiconductor device comprising all claimed limitations. See the rejections of claims 4-9/ and figs. 5b, 6, 9, 11, and col. 4, line 10 to col. 7, line 25 of Ker.

Regarding claim 27, Ker/Wang/Beigel discloses the semiconductor device further comprising a third region (silicide material Emitter contact region shown by shaded region in the first well or left emitter 38 (col. 4, lines 38-39)) formed in the substrate, wherein the third region is a contact to the first well (left emitter) 38;
a fourth doped region 40 formed in the second well 32; and

a fifth region (silicide material Emitter contact region shown by shaded region in the first well or right emitter 38 (col. 4, lines 38-39)) formed in the substrate 32, wherein the fifth region is a contact to the third well (right emitter) 38,

wherein the first and second doped regions 36 are connectable to a contact pad for receiving an ESD in an ESD event, the third and fifth regions are connectable to a power supply, and the fourth doped 40 region is connectable to an ESD detection circuit, wherein the ESD detection circuit is coupled to the contact pad for detecting the ESD. See figs. 5b, 6, 9, 11; and col. 4, line 36-64 of Ker.

Ker/Wang teaches that the third and fifth regions are silicide material regions (col. 4, lines 38-39 and lines 53-56 of Ker) but not doped regions.

Beigel discloses a semiconductor device for an ESD circuit, as shown in figs. 3, 5, 6, wherein electrical contact(s) to the collector/emitter and/or base is/are made via highly doped layer(s) which correspondingly has/have the same type of conductivity with that of the collector/emitter and base (N^{++} doped layer 26 is formed in, and contacts, the N-type collector 24 (col. 3, lines 22-25); and P^{++} doped layer 36 is formed in, and contacts, the P-type base 32 (col. 3, lines 36-40)).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to further modify the invention of Ker/Wang so that the silicide contact regions (third and fifth regions) formed in the collector/emitter, regions

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are replaced by correspondingly highly doped regions of N-type or P-type as those of Beigel in order to assure good electrical contacts to the collector/emitter regions. See col. 3, lines 34-40 of Beigel.

Regarding claim 29, Ker/Wang/Beigel discloses the semiconductor device wherein the ESD detection circuit triggers the first and second BJTs to conduct the ESD current from the first and second doped regions 36 to the third and fifth doped regions, respectively, or from the third and fifth doped regions to the first and second doped regions 36, respectively. See col. 2, lines 56-60, col. 4, line 16-36, and col. 5, lines 38-64 of Ker.

Regarding claims 30 and 31, Ker/Wang/Beigel discloses the semiconductor device comprising all claimed limitations. See figs. 5b, 6, 9, 11; col. 2, lines 56-60, col. 4, line 16-36, and col. 5, lines 38-64 of Ker.

Allowance

8. Claim(s) 16-25 are allowed. The reason for allowance can be found in the previous Office Action.

Allowable Subject Matter

9. Claim(s) 28 is objected to as being dependent upon a rejected base claim 26, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims, since the prior art of record and considered pertinent to the applicant's disclosure does not teach or suggest the claimed semiconductor device (in addition to the other limitations in the claim) wherein a portion of the third doped region is formed in the first well, and another portion of the third doped region is formed in the second well, and wherein a portion of the fifth doped region is formed in the second well, and another portion of the fifth doped region is formed in the third well.

Conclusion

10. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within **TWO MONTHS** of the mailing date of this final action and the advisory action is not mailed until after the end of the **THREE-MONTH** shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

11. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dao Nguyen whose telephone number is (571)272-1791. The examiner can normally be reached on Monday-Friday 9:00am - 6:00pm. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith, can be reached on (571)272-1907. The fax numbers for all communication(s) is (571)273-8300.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (571)272-1625.

A handwritten signature in black ink, appearing to read 'Dao', with a long horizontal line extending to the right.

Dao H. Nguyen
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August 10, 2006

A handwritten signature in black ink, appearing to read 'Douglas W. Owens', followed by the date '8/18/06'.

DOUGLAS W. OWENS
PRIMARY EXAMINER